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[54]	TRANSPARENT CONDUCTIVE SUBSTRATE AND METHOD OF MAKING THE SAME					
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57] ABSTRACT

A transparent conductive substrate comprising a base plate member allowing transmission therethrough of visible light, a transparent, overcoat layer formed on the base plate member, and a transparent conductive film which is formed on the overcoat layer, containing ultra-fine particles of indium-tin oxide having a particle size of 0.1 μm or smaller, having light transmittance of 70% or higher and exhibiting surface resistance of 200 Ω/\Box lower. This transparent conductive substrate has low surface resistance and excellent optical characteristics.

22 Claims, 4 Drawing Sheets



